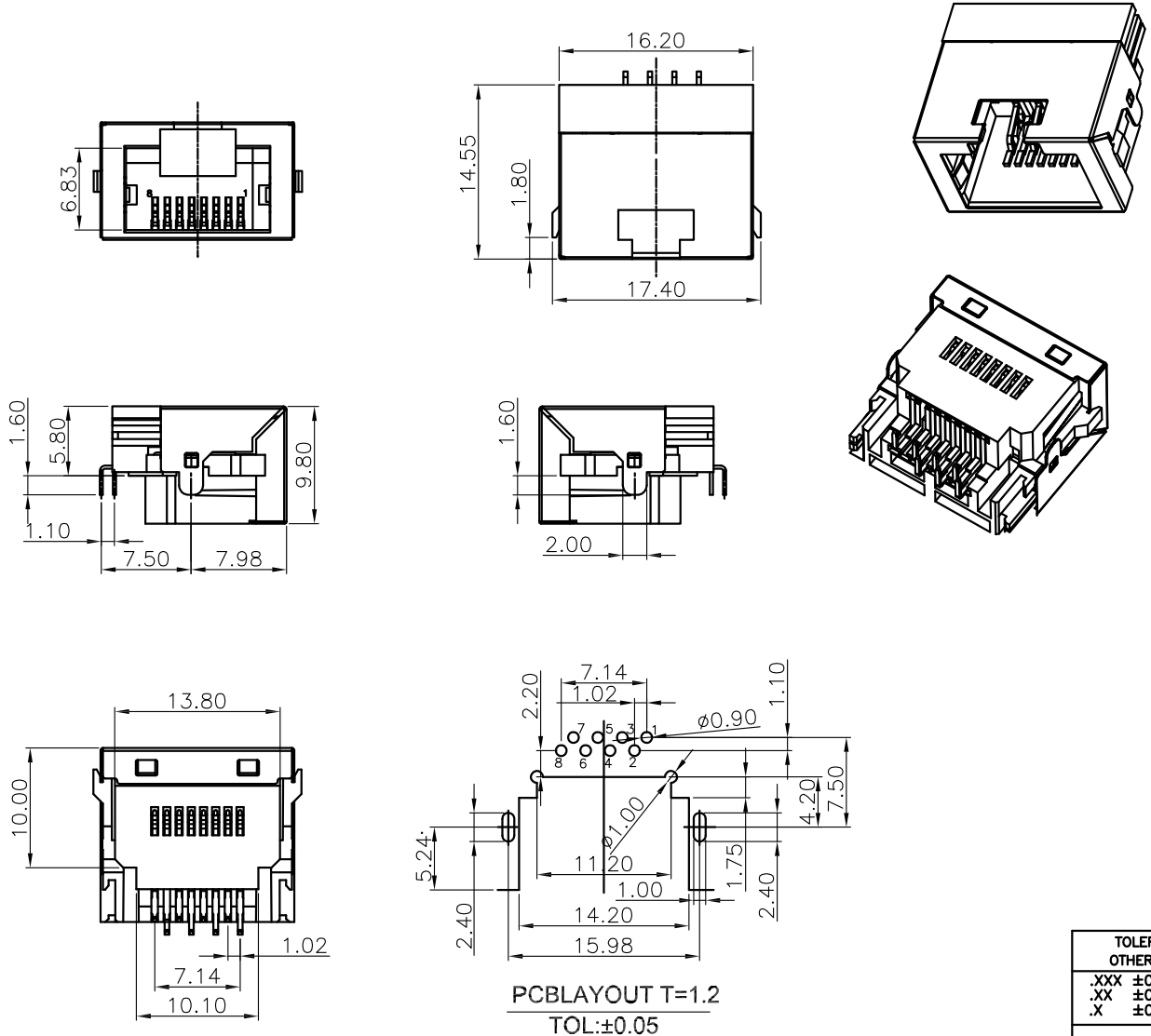


REV.	ECN.NO.	APPD.
A	/	chenyiting



NOTES:
 1.MATERIAL:
 1.1 Housing:Thermoplastic plastics
 1.2 Contact:Copper Alloy
 Au plated on contact area
 Tin plating on solder tail
 Nickel under plating over all
 1.3 Shell:Copper Alloy
 Nickel plating over all
 2.characteristics:
 2.1 Rating Voltage : 125V AC RMS
 2.2 Rating Current:500 mA
 2.3 Contact Resistance:40 mΩ MAX.
 2.4 Insulation Resistance:100 MΩ MIN.
 2.5 Withstanding Voltage:AC 500V between adjacent contacts
 2.6 Mating force: 30N/3.0KG Max
 2.7 Life test:750Cycles MIN.
 2.8 Temperature Range: -40℃~+85℃.
 The product must be compliance ROHS

R520-32000-G61018
 G:半金G/Fu”
 1:吸塑盒
 6:LCP
 1:黑色

TOLERANCE UNLESS OTHERWISE SPECIFIED		FLW 深圳市华联威电子科技有限公司			
.XXX ±0.10 .XX ±0.20 .X ±0.30		.X ±3° .XX ±2°		HUA LIAN WEI TECHNOLOGY ELECTRONICS CO;LTD.	
APPROVED		PART NAME:	RJ45 90度 9.9H 沉板5.8 无灯		
CHECKED		PART No:	R520-32000-G61018	C	
DRAWN	chenyiting	PROJECTION:	UNIT:	SCALE	SHEET
DATE	2022.05.22		mm	1:1	10F1
				REV.	A